

# EGP20A - EGP20K

## 2.0 Ampere Glass Passivated High Efficiency Rectifiers

### Features

- Glass passivated cavity-free junction
- High surge current capability
- Low leakage current
- Superfast recovery time for high efficiency
- Low forward voltage, high current capability



**DO-15 Glass case**  
COLOR BAND DENOTES CATHODE

### Absolute Maximum Ratings\* T<sub>a</sub> = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
I <sub>O</sub>	Average Rectified Current .375" lead length @ T <sub>L</sub> = 55°C	2.0	A
I <sub>f(surge)</sub>	Peak Forward Surge Current 8.3 ms single half-sine-wave Superimposed on rated load (JEDEC method)	75	A
P <sub>D</sub>	Total Device Dissipation Derate above 25°C	3.13 25	W mW/°C
R <sub>θJA</sub>	Thermal Resistance, Junction to Ambient	40	°C/W
R <sub>θJL</sub>	Thermal Resistance, Junction to Lead	15	°C/W
T <sub>J</sub> , T <sub>STG</sub>	Junction and Storage Temperature Range	-65 ~ 150	°C

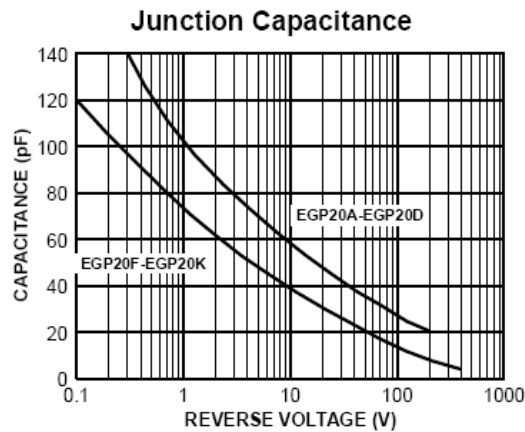
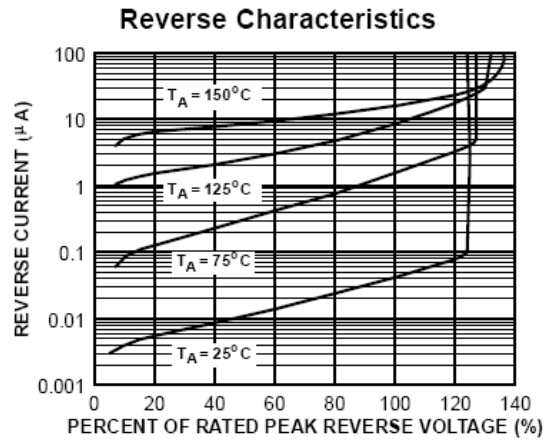
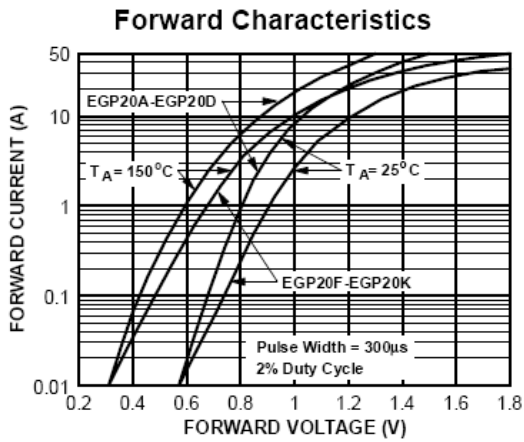
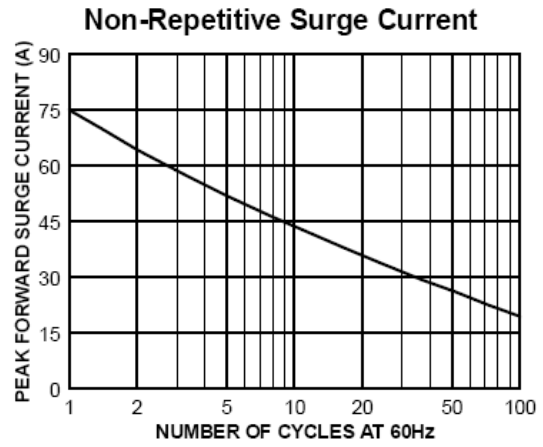
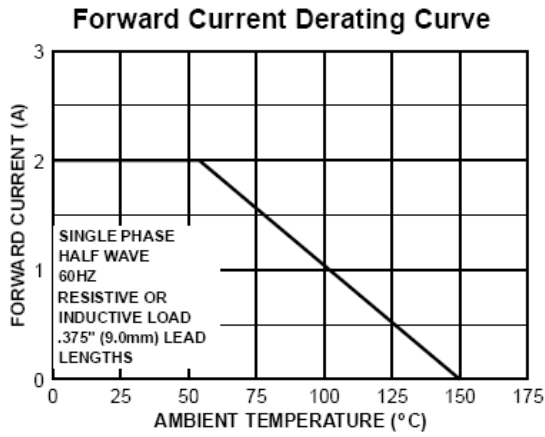
\* These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

### Electrical Characteristics\* T<sub>a</sub> = 25°C unless otherwise noted

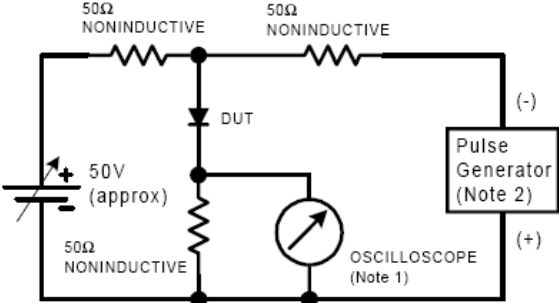
Parameter	Device								Units
	20A	20B	20C	20D	20F	20G	20J	20K	
Peak Repetitive Reverse Voltage	50	100	150	200	300	400	600	800	V
Maximum RMS Voltage	35	70	105	140	210	280	420	560	V
DC Reverse Voltage (Rated V <sub>R</sub> )	50	100	150	200	300	400	600	800	V
Maximum Reverse Current @ rated V <sub>R</sub> T <sub>A</sub> = 25°C T <sub>A</sub> = 125°C	5.0 100								μA μA
Maximum Reverse Recovery Time I <sub>F</sub> = 0.5 A, I <sub>R</sub> = 1.0 A, I <sub>rr</sub> = 0.25 A	50						75		nS
Maximum Forward Voltage @ 2.0 A	0.95				1.25		1.7		V
Typical Junction Capacitance V <sub>R</sub> = 4.0 V, f = 1.0 MHz	70				45				pF

\* Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2%

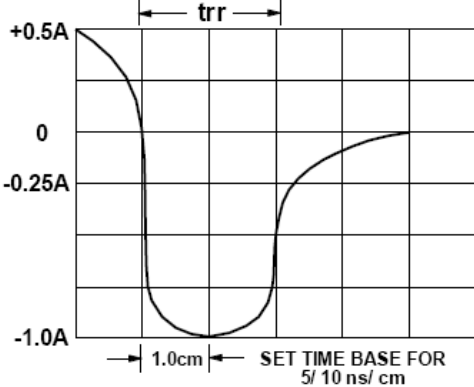
## Typical Performance Characteristics



**Reverse Recovery Time Characteristic and Test Circuit Diagram**



- NOTES:  
 1. Rise time = 7.0 ns max; Input impedance = 1.0 megaohm 22 pf.  
 2. Rise time = 10 ns max; Source impedance = 50 ohms.




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